

Ultra Fast IGBT Modules

SKM 600GA125D

Features

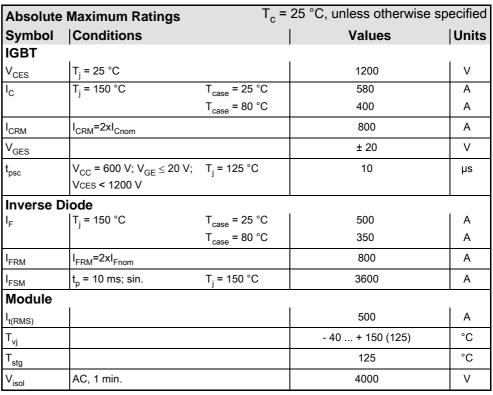
- NPT-IGBT with positive temperature coeffecient of V_{CEsat}
- Short circuit self limiting to 6 x I_c
- Corresponds to standards: IEC 60721-3-3 (humidity) class 3K3/IEC 68T.1 climate 40/125/56

Typical Applications*

- Resonant inverters upto 100 kHz
- Inductive heating
- Electronic welders at f_{SW} >20 kHz

Remarks

- I_{DC} ≤ 500A limited by terminals
- Take care of over-voltage caused by stray inductances.



Characteristics		T_c = 25 °C, unless otherwise specified				
Symbol	Conditions		min.	typ.	max.	Units
IGBT						
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_{C} = 16 \text{ mA}$		4,5	5,5	6,5	V
I _{CES}	$V_{GE} = 0 V, V_{CE} = V_{CES}$	T _j = 25 °C		0,15	0,45	mA
V _{CE0}		T _j = 25 °C		1,5	1,75	V
		T _j = 125 °C		1,7		V
r _{CE}	V _{GE} = 15 V	T _j = 25°C		4,5	5,3	mΩ
		T _j = 125°C		6		mΩ
V _{CE(sat)}	I _{Cnom} = 400 A, V _{GE} = 15 V	T _j = 25°C _{chiplev.}		3,3	3,85	V
		$T_j = 125^{\circ}C_{chiplev.}$		4		V
C _{ies}				36		nF
C _{oes}	$V_{CE} = 25, V_{GE} = 0 V$	f = 1 MHz		3,8		nF
C _{res}				3,5		nF
Q_G	V _{GE} = -8V - +20V			4400		nC
R _{Gint}	T _j = °C			1,25		Ω
t _{d(on)}				80		ns
t _r	$R_{Gon} = 2.5 \Omega$	V _{CC} = 600V		70		ns
E _{on}		I _C = 400A		30		mJ
t _{d(off)}	R_{Goff} = 2,5 Ω	T _j = 125 °C		570		ns
t _f		$V_{GE} = \pm 15V$		60		ns
E _{off}						mJ
$R_{\text{th(j-c)}}$	per IGBT				0,041	K/W





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Characteristics							
Symbol	Conditions		min.	typ.	max.	Units	
Inverse Diode							
$V_F = V_{EC}$	$I_{Fnom} = 400 \text{ A}; V_{GE} = 0 \text{ V}$			2	2,5	V	
		$T_j = 125 ^{\circ}C_{\text{chiplev.}}$		1,8		V	
V_{F0}		T _j = 25 °C		1,1	1,2	V	
		T _j = 125 °C				V	
r _F		T _j = 25 °C		2,3	3,3	mΩ	
		T _j = 125 °C				$m\Omega$	
I _{RRM}	I _F = 400 A	T _j = 125 °C		460		Α	
Q_{rr}				65		μC	
E _{rr}	$V_{GE} = 0 \text{ V}; V_{CC} = 600 \text{ V}$					mJ	
$R_{th(j-c)D}$	per diode				0,09	K/W	
Module							
L _{CE}				15	20	nH	
R _{CC'+EE'}	res., terminal-chip	T _{case} = °C		0,18		mΩ	
$R_{\text{th(c-s)}}$	per module				0,038	K/W	
M _s	to heat sink		3		5	Nm	
M _t	to terminals		2,5 (1,1)		5 (2)	Nm	
W					330	g	

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.





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Z _{th} Symbol	Conditions	Values	Units
-	Conditions	Value3	Office
Z _{th(j-c)l}	i = 1	29	mk/W
r _i			
K _i	i = 2	9	mk/W
R _i R _i	i = 3	2,6	mk/W
R _i	i = 4	0,4	mk/W
tau _i	i = 1	0,1043	s
tau _i	i = 2	0,009	S
tau _i	i = 3	0,001	s
tau _i	i = 4	0,0002	s
Z			
Z _{th(j-c)D}	i = 1	62	mk/W
R_i	i = 2	23	mk/W
R_i	i = 3	4,2	mk/W
R_i	i = 4	0,8	mk/W
tau _i	i = 1	0,0566	s
tau _i	i = 2	0,0166	s
tau _i	i = 3	0,0015	s
tau _i	i = 4	0,0002	s

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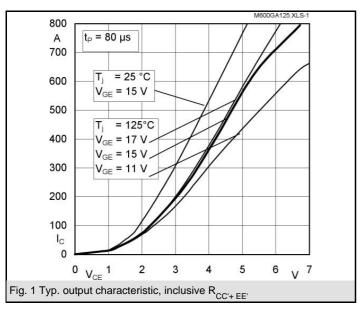
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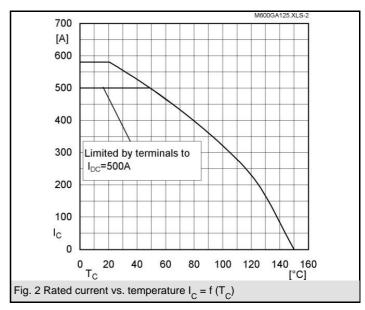
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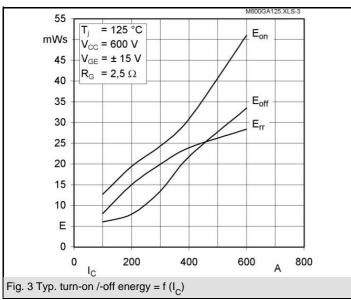
Remarks

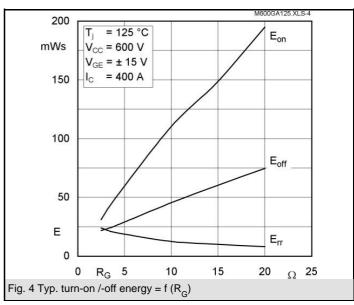
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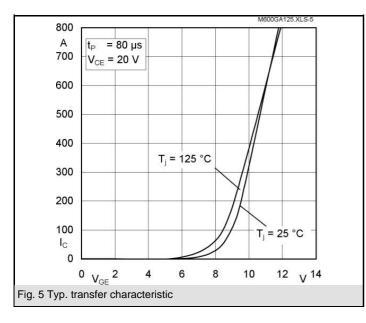


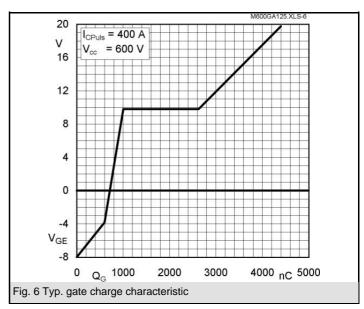


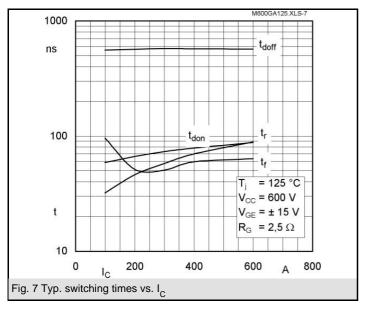


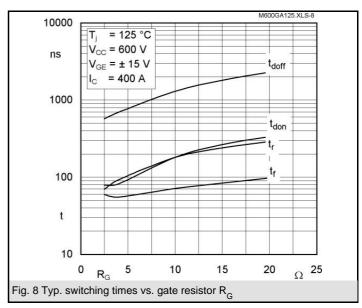


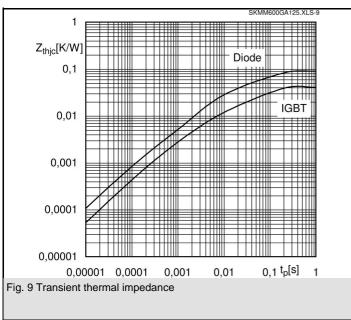


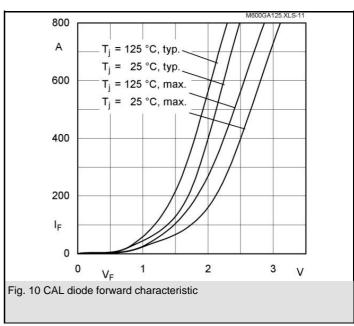


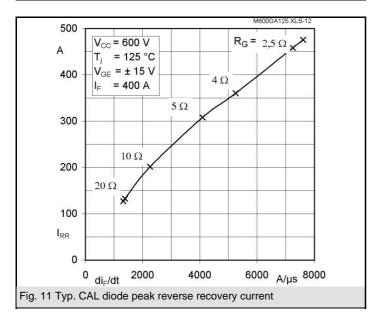


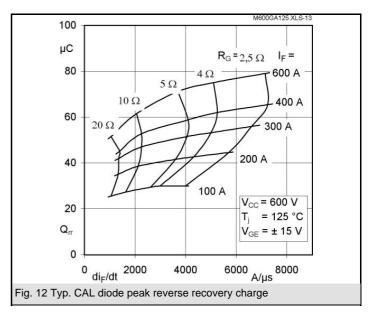


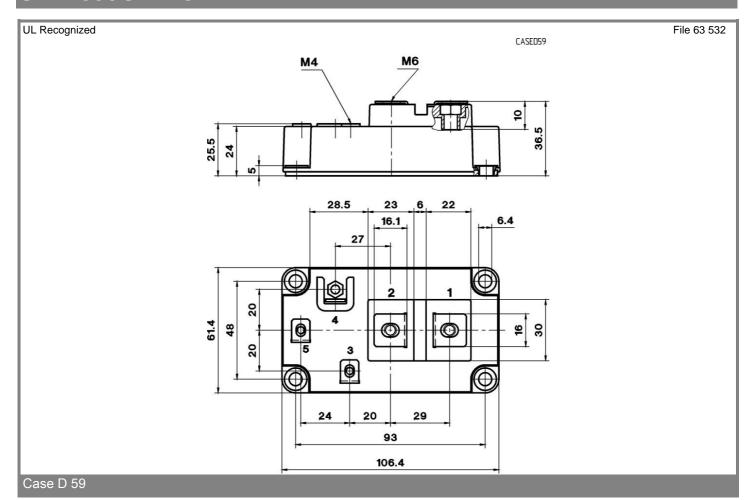


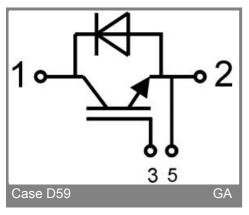












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